**Product data sheet** 

# 1. General description

Hyperfast power diode (Bare die after sawn).

## 2. Features and benefits

- Low Forward Voltage Drop
- Low leakage current
- · Fast reverse recovery
- Bare die

## 3. Quick reference data

### Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes		Values		Unit
$V_{RRM}$	repetitive peak reverse voltage		[1]		1200		V
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; square-wave pulse	[2]		5		А
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static characteristics							
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 5 A; T <sub>j</sub> = 25 °C	[2]	-	2.40	3.20	V
Dynamic characteristics							
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A}$ ; $V_R = 30 \text{ V}$ ; $dI_F/dt = 100 \text{ A/}\mu\text{s}$ ; $T_j = 25 ^{\circ}\text{C}$	[2]	-	36	-	ns

# 4. Ordering information

## **Table 2. Ordering information**

Product type	Orderable part number	Description	Packing method
WB05FC120AL	WB05FC120ALZ	Bare die on wafer	Unsawn wafer, Vacuum packing

# 5. Limiting values

## **Table 3. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
$V_{RRM}$	repetitive peak reverse voltage		[1]	1200	V
$V_{RWM}$	crest working reverse voltage		[1]	1200	V
$V_R$	reverse voltage	DC	[1]	1200	V
I <sub>F(AV)</sub>	average forward current	δ = 0.5; square-wave pulse	[2]	5	Α
I <sub>FRM</sub>	repetitive peak forward current	$\delta$ = 0.5; $t_p$ = 25 µs; square-wave pulse	[2]	10	Α
	non-repetitive peak forward	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	[2]	55	Α
	current	$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	[2]	60	Α
T <sub>j</sub>	junction temperature			-40 to 175	°C

## 6. Characteristics

### **Table 7. Characteristics**

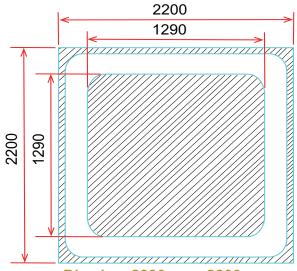
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics						
$V_{F}$	forward voltage	I <sub>F</sub> = 5 A; T <sub>j</sub> = 25 °C	[2]	-	2.40	3.20	V
		I <sub>F</sub> = 5 A; T <sub>j</sub> = 150 °C	[2]	-	2.00	-	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 1200 V; T <sub>j</sub> = 25 °C	[1]	-	-	100	μΑ
		V <sub>R</sub> = 1200 V; T <sub>j</sub> = 150 °C	[2]	-	-	500	μΑ
Dynamic	characteristics						
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 100 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}$	[2]	-	36	-	ns
		$I_F = 5 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 500 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}$	[2]	-	42	-	ns

#### Notes:

<sup>[1]</sup> means that parameter are 100% test at  $T_{amb}$  = 25°C. [2] means that the guaranteed ratings and parameter limits will depend on the assembled structure. When correctly assembled with suitable die bonding and wire bonding, the device will have ratings and characteristics guaranteed in this data sheet, similar to the assembled devices.

MECHANICAL PATAMETER			
Chip size	2.2 x 2.2	mm <sup>2</sup>	
Anode pad size	1.29 x 1.29	mm <sup>2</sup>	
Area total / active	4.84 / 1.66	mm²	
Thickness	300	μm	
Wafer size	125	mm	
Max possible chips per wafer	2229	pcs	
Passivation	P.E.C.V.D./ Planar		
Front metal	Al		
Back metal	Ti Ni Ag		

### **CHIP LAYOUT**



Die size: 2200μm x 2200μm Bond pad size: 1290μm x 1290μm

## 7. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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For more information, please visit: http://www.ween-semi.com
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